

**12 A Three-quadrant triacs high commutation** Rev. 01 — 13 March 2007

**Product data sheet** 

### 1. Product profile

### 1.1 General description

Passivated, new generation, high commutation triacs, in a SOT78 plastic package.

### 1.2 Features

Very high commutation performance
 High immunity to dV/dt maximized at each gate sensitivity

### 1.3 Applications

- High power motor control e.g. washing machines, vacuum cleaners
- Refrigeration and air conditioning compressors

### 1.4 Quick reference data

- V<sub>DRM</sub> ≤ 600 V (BTA312-600B/C)
- V<sub>DRM</sub> ≤ 800 V (BTA312-800B/C)
- I<sub>TSM</sub>  $\leq$  95 A (t = 20 ms)

- Non-linear rectifier-fed motor loads
- Electronic thermostats
- I<sub>GT</sub>  $\leq$  50 mA (BTA312 series B)
- I<sub>GT</sub>  $\leq$  35 mA (BTA312 series C)
- I<sub>T(RMS)</sub>  $\leq$  12 A

SOT78 (TO-220AB)

### 2. Pinning information

Table 1.	Pinning		
Pin	Description	Simplified outline	Symbol
1	main terminal 1 (T1)		N 1
2	main terminal 2 (T2)	mb	T2-T1
3	gate (G)	ך 🔾 ۲	sym051
mb	mounting base; main terminal 2 (T2)		



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## 3. Ordering information

Table 2.         Ordering information								
Type number	Package							
	Name	Description	Version					
BTA312-600B	SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole;	SOT78					
BTA312-600C		3-lead TO-220AB						
BTA312-800B								
BTA312-800C								

## 4. Limiting values

#### Table 3. Limiting values

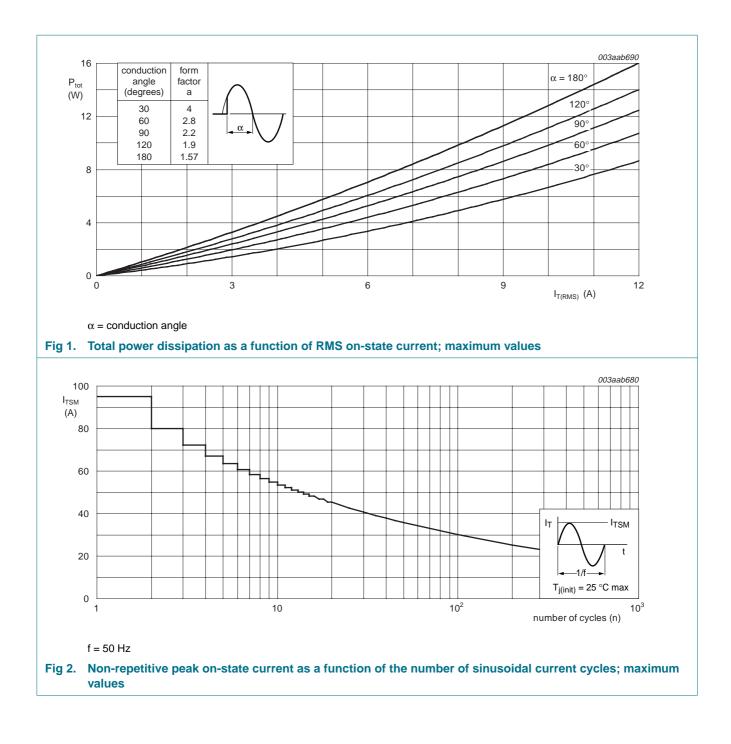
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DRM</sub>	repetitive peak off-state voltage	BTA312-600B; BTA312-600C	<u>[1]</u> -	600	V
		BTA312-800B; BTA312-800C	-	800	V
I <sub>T(RMS)</sub>	RMS on-state current	full sine wave; $T_{mb} \le 101 \text{ °C}$ ; see Figure 4 and 5	-	12	A
I <sub>TSM</sub>	non-repetitive peak on-state current	full sine wave; $T_j = 25 \text{ °C prior to}$ surge; see <u>Figure 2</u> and <u>3</u>			
		t = 20 ms	-	95	А
		t = 16.7 ms	-	105	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t = 10 ms	-	45	A <sup>2</sup> s
dl <sub>T</sub> /dt	rate of rise of on-state current	$I_{TM} = 20 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu \text{s}$	-	100	A/μs
I <sub>GM</sub>	peak gate current		-	2	А
P <sub>GM</sub>	peak gate power		-	5	W
P <sub>G(AV)</sub>	average gate power	over any 20 ms period	-	0.5	W
T <sub>stg</sub>	storage temperature		-40	+150	°C
T <sub>i</sub>	junction temperature		-	125	°C

[1] Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.

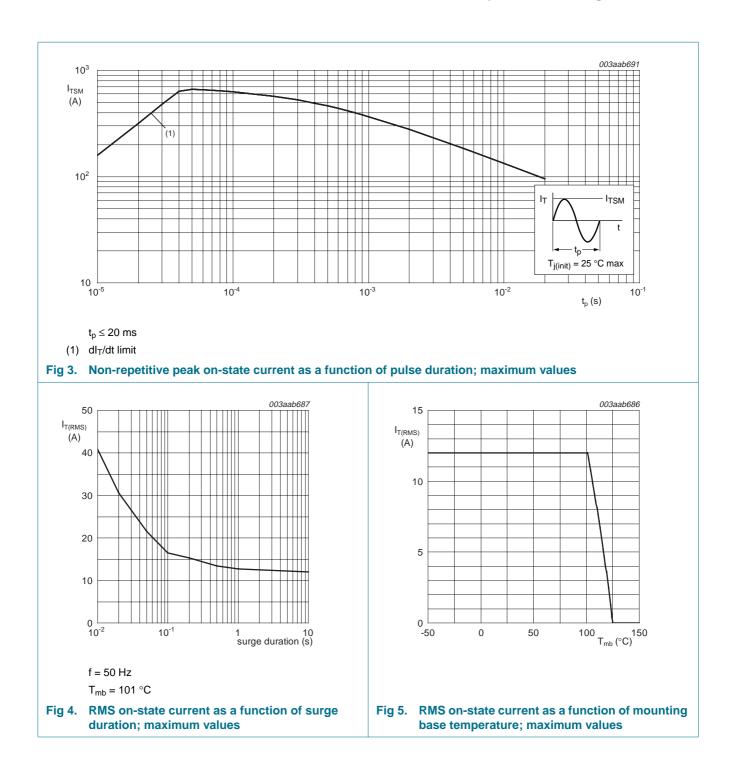
## BTA312 series B and C

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## BTA312 series B and C

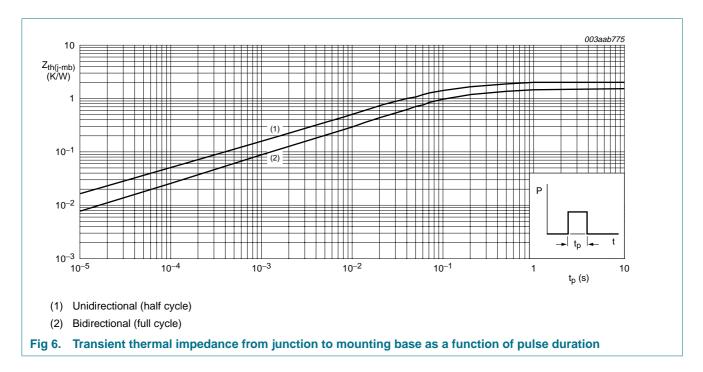
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### 5. Thermal characteristics

Table 4.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	half cycle; see Figure 6	-	-	2.0	K/W
		full cycle; see Figure 6	-	-	1.5	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	-	60	-	K/W



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## 6. Static characteristics

#### Table 5. Static characteristics

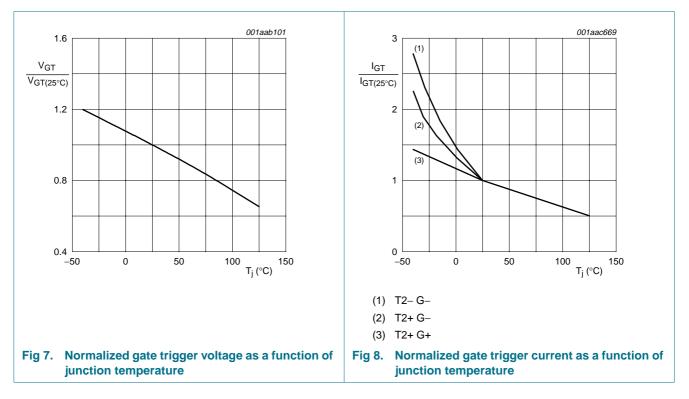
 $T_i = 25 \circ C$  unless otherwise specified.

Symbol	Parameter	Conditions		BTA312-600B BTA312-800B			BTA312-600C BTA312-800C			
				Тур	Max	Min	Тур	Max		
I <sub>GT</sub>	gate trigger	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 8}}{\text{Figure 8}}$								
current		T2+ G+	2	-	50	2	-	35	mA	
	T2+ G-	2	-	50	2	-	35	mA		
		T2- G-	2	-	50	2	-	35	mA	
١L	latching current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure } 10}{100000000000000000000000000000000$								
		T2+ G+	-	-	60	-	-	50	mA	
		T2+ G-	-	-	90	-	-	60	mA	
		T2- G-	-	-	60	-	-	50	mA	
I <sub>H</sub>	holding current	$V_{D} = 12 \text{ V}; I_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure } 11}{100000000000000000000000000000000$	-	-	60	-	-	35	mA	
V <sub>T</sub>	on-state voltage	I <sub>T</sub> = 15 A; see <u>Figure 9</u>	-	1.3	1.6	-	1.3	1.6	V	
V <sub>GT</sub>	gate trigger	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 7}}{100000000000000000000000000000000000$	-	0.8	1.5	-	0.8	1.5	V	
	voltage	$V_D = 400 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T}_j = 125 \ ^\circ\text{C}$	0.25	0.4	-	0.25	0.4	-	V	
I <sub>D</sub>	off-state current	$V_D = V_{DRM(max)}; T_j = 125 \ ^{\circ}C$	-	0.1	0.5	-	0.1	0.5	mA	

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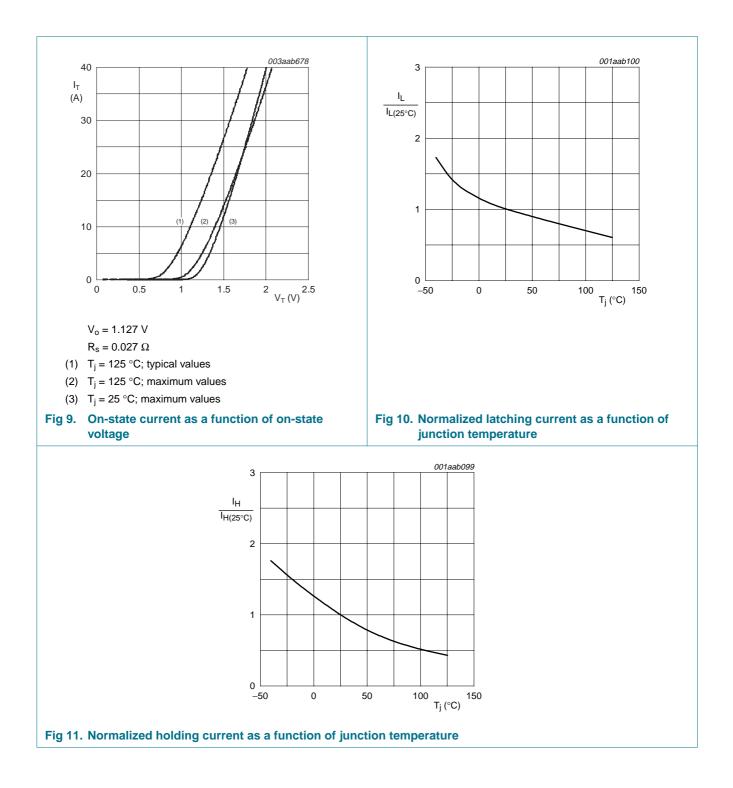
## 7. Dynamic characteristics

Table 6.	Dynamic cha	racteristics							
Symbol	Parameter	Conditions		BTA312-600B BTA312-800B			BTA312-600C BTA312-800C		
			Min	Тур	Max	Min	Тур	Max	
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM}$ = 0.67 × $V_{DRM(max)}$ ; $T_j$ = 125 °C; exponential waveform; gate open circuit	1000	2000	-	500	-	-	V/µs
dI <sub>com</sub> /dt	rate of change of commutating current	$V_{DM}$ = 400 V; $T_{j}$ = 125 °C; $I_{T(RMS)}$ = 12 A; without snubber; gate open circuit	30	-	-	20	-	-	A/ms
t <sub>gt</sub>	gate-controlled turn-on time	$\begin{split} I_{TM} &= 20 \text{ A};  V_D = V_{DRM(max)};  I_G = 0.1 \text{ A}; \\ dI_G/dt &= 5  A/\mu s \end{split}$	-	2	-	-	2	-	μs



## BTA312 series B and C

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## **BTA312 series B and C**

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## 8. Package outline

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#### Fig 12. Package outline SOT78 (3-lead TO-220AB)

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## 9. Revision history

Table 7. Revision hist	Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes			
BTA312_SER_B_C_1	20070313	Product data sheet	-	-			

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#### **10.1** Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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## BTA312 series B and C

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